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1. Introduction

This document pertains to the flight acceptance test procedures for the GPB guide star telescope's optical radiation detectors. The test procedures specified are in accordance with the SIA Specification Matrix (PLSE-12 [F277277] ° 3.7.1).

1.1 Definitions

Reference Materials

| Item | PLSE 13 ° | Control Document | Release Date | RE |
|--|------------------------|---------------------|-----------------|---------------------|
| Telescope Drawing Tree | | 23200-118 | 8/8/97 | Huff |
| DPA Mechanical Drawing | 3.2.3.3 .14 | 25712-101 | 11/26/97 | Sullivan |
| | | 25712-102 | “ | “ |
| | | 25712-103 | “ | “ |
| | | 25712-104 | “ | “ |
| | | 25712-201 | “ | “ |
| | | 25712-202 | “ | “ |
| | | 25712-203 | “ | “ |
| | | 25712-204 | “ | “ |
| DPA Manufacturing Plan | | | | Goebel |
| DPA Manufacturing Readiness Review | | | | Ehrensberger |
| Telescope Readout Electronics (TRE) Mechanical Design | 3.2.4.1 .1 | | | Farley |
| Telescope Readout Electronics (TRE) Electrical Design | | | | Farley |
| Telescope Readout Electronics Manufacturing Plan | | | | Farley |
| SIA Mechanical Drawing Tree | | 23200-106 | 11/18/96 | Turneure |
| SIA Readiness Review | | | | |

1.1.1 Thermal Isolator

The Thermal Isolator (TI) is a component of the Detector Mount Assembly used in the Gravity Probe B General Relativity Experiment. The TI is photolithographically produced and bonded into a DMA. It serves the function of thermal isolation in a vacuum between the detector platform, which must operate above 30 K in temperature, and the cryogenic heatsink,

which is at 2.1 K. It also serves as a flexible printed circuit to carry signals between the detector platform and the warm electronics outside the cryogenic vessel. The size of the DMA is similar to that of a gambling die.

Reference Materials

| Item | Control Document | Release Date | RE |
|------------------|-------------------------|---------------------|-----------|
| Thermal Isolator | 25408-201 | 7/03/97 | Sullivan |

1.1.2 Circuit Assembly Pedestal

The Circuit Assembly Pedestal (CAP) contains the Cold Telescope Readout Electronics (CTRE) that convert the optical signal presented by the telescope to electronic signal that can be used for tracking purposes by the Science Readout Electronics (SRE).

Reference Materials

| Item | Control Document | Release Date | RE |
|---------------------------|-------------------------|---------------------|-----------|
| Circuit Assembly Pedestal | 25701-102 | 2/21/98 | Sullivan |

1.1.3 Detector Mount Assembly

The Detector Mount Assembly (DMA) is a subassembly of the Detector Package Assembly (DPA). The DMA consists of a Detector Platform, TI, Titanium base, and Connector Plug Assembly. The DMA provides the mechanical, electrical, and thermal configuration to interface the Optical Detectors and Preamplifier Electronics with the rest of the telescope.

Reference Materials

| Item | Control Document | Release Date | RE |
|-------------------------|-------------------------|---------------------|-----------|
| Detector Mount Assembly | 25681 | 10/30/97 | Sullivan |

1.1.4 Flexible Cable Assembly

The Flexible Cable Assembly (FCA) transports the electrical signals from a single DMA forth and back to the Science Probe wiring and thereby to the Warm Telescope Readout Electronics (WTRE) that is external to the Science Probe and Science Dewar. A full set of cables consists of four unique layouts, one for each DMA in a full complement of four DMAs configured in two DPAs.

Reference Materials

| Item | Control Document | Release Date | RE |
|-------------------------|-------------------------|---------------------|-----------|
| Flexible Cable Assembly | 25674-101 | 9/16/97 | Sullivan |
| “ | 25674-102 | “ | “ |
| “ | 25674-103 | “ | “ |
| “ | 25674-104 | “ | “ |
| “ | 25674-201 | “ | “ |
| “ | 25674-202 | “ | “ |
| “ | 25674-203 | “ | “ |
| “ | 25674-204 | “ | “ |

1.1.5 Detector Package Assembly

The Detector Package Assembly consists of two DMAs, two FCA's and a titanium housing that presents the telescope optical beams to the photodetectors with the aid of a lens and beamsplitter.

Reference Materials

| Item | Control Document | Release Date | RE |
|---------------------------|-------------------------|---------------------|-----------|
| Detector Package Assembly | 25712-101 25712-102 | 11/26/97 “ | Sullivan |

1.2 Purpose

This acceptance test plan is intended to pass on the functionality of the DPA test article(s) for flight operation after launch on a Delta II launch vehicle. The DPA test article(s) to be used in the test plan are to be engineering prototypes and flight qualifiable units. These DPA's will be considered acceptable for integration with the Science Probe and Flight Telescope if they pass all procedures specified in this document.

2. Test Summary and Objectives

2.1 DPA Acceptance Test Summary and Objectives

The objectives of the tests are to:

1. Measure and certify the optical responsivity of the DPA.
2. Measure and certify the electronic noise level of the DPA.
3. Measure and certify the sense node leakage current of the DPA.
4. Measure and certify the heater control and power dissipation performance of the DPA.
5. Measure and certify the temperature coefficient of bias of the preamplifier circuit.

Tests are to be performed to meet the verification and specification requirements that flow down from T-003, that is specifically SIA Specification Matrix (PLSE-12 [F277277] ° 3.7.1) and their subsequent embodiment in the TRE Spec [PLSE-13 Pt 3]. The conversion of the Science requirements into Engineering parameters is derived in 3.2.15.1, an attached document to PLSE 13, pt3, and are specified in Section 3.2.3.1, Telescope Readout Electronics (Appendix A). The relevant line items thereof are:

SIA Specification (PLSE-12 [F277277] §3.7.1) Verification Matrix

| Section | Title | Text |
|---------------|-------------------|--|
| 3.7.1.6.1.2.2 | Signal Interfaces | <p>The ST shall output to the Telescope Readout Electronics eight optical signals as listed below.</p> <p>Positive Pitch Axis Alternate Positive Pitch Axis Negative Pitch Axis Alternate Negative Pitch Axis Positive Yaw Axis Alternate Positive Yaw Axis Negative Yaw Axis Alternate Negative Yaw Axis</p> <p>The detailed electrical interface to the probe with identification of the electrical function is given in Section 3.7.6.2.2.</p> |

DPA Requirements (extracted from TRE Spec [PLSE-13 Pt 3])

| Paragraph | Title | Text & Comments | Method | Verification Plan |
|-----------|---|-------------------------|--------|--|
| 3.2.5.3 | Platform Temperature Variation at Roll Frequency, as defined in T003, 7.6.2 | ≤ 2 mK | A,T | Payload level verification |
| 3.2.6.1 | Total Telescope Detector Power (All Detectors) | <6 mW (1.5 mW/platform) | T | P392: Power Dissipation Test |
| 3.2.18 | TRE Detector Performance Requirement | | | |
| 3.2.18.1 | External Quantum Efficiency at 400 to 900 nm wavelength | >70% | S,A,T | <u>P0392</u> : Optical Responsivity test one flight unit will be tested over several wavelength and use similarity for other flight units. S-Doc TBS |
| 3.2.18.2 | External Quantum Efficiency at 550nm wavelength | >70 % | T | <u>P0392</u> : Optical Responsivity test |
| 3.2.18.3 | I_Dark | <0.01 fA@80 K | T | <u>P0392</u> : Electrical Leakage Current Test. Measure w/o light and at V_detB=4.0V @T_op 80 |
| 3.2.18.4 | Diameter of Photoactive Area | 0.8 mm | I | <u>P332</u> |

| | | | | |
|----------|----------------------------------|--------------------------|-----|---|
| 3.2.18.6 | Operating Temperature (Si JFETs) | 80 K ± 10 | T | P0392 : Temperature Stability Test Measure without light and at V_detB=4.0V @80 K with all components |
| 3.2.18.7 | Random Noise | <50 e rms/(0.1 sec read) | T | P0392: Noise test |
| 3.2.18.8 | Temperature Coefficient of Bias | < 440 e/(read)/K | A,T | P0392: Temperature Stability Test |

2.2 Characterization Test Summary and Objectives

The characterization test that are to be conducted are aimed at understanding the contribution of several testable parameters to the pointing bias variation.

The TRE ETU is able to drive a limited set of parameters, that are summarized in the table below. These are described in the manual describing using the TRE Support Systems prepared by Bob Farley, dated Dec 1997.

ETU Controllable Parameters That Affect Flight Telescope Pointing Bias Variation

| Controllable Parameter | TRE ETU Command Parameter | ETU Input Test Signal | TRE ETU Input Command Address Range | | ETU Output Signal |
|---------------------------|---------------------------|-----------------------|-------------------------------------|------------|-------------------|
| | | | Voltage Limits | Hex Limits | |
| + Direction Clamp Voltage | CLAMP | Dynamic | Gain Depend | 00_FF | |
| - Direction Clamp Voltage | CLAMP | Dynamic | Gain Depend | 00_FF | |
| Direction Clamp Voltage | CLAMP | Dynamic | Gain Depend | 00_FF | |
| +Reference or Reset Level | SBIAS (OFFSETS) | Dynamic | ±20 mV | 00_FF | |
| -Reference or Reset Level | SBIAS (OFFSETS) | Dynamic | ±20 mV | 00_FF | |
| Reference or Reset Level | SBIAS (OFFSETS) | Dynamic | ±20 mV | 00_FF | |
| Diode Bias | PBIAS | Dynamic | -7_0 V | 00_FF | |

| | | | | | |
|----------------|---------|---------|-------|-------|-----|
| Voltage | (BIAS) | | | | |
| Heater Voltage | HEAT | Dynamic | 0 10V | 00 FF | |
| Control | CONTROL | Static | N/A | N/A | N/A |

3. Test Articles

The test articles are to be engineering units and flight hardware. These articles are to be supplied by Stanford University, Gravity Probe B, Telescope Readout Electronics, Cryogenic Optical Telescope Sensor Group. The test articles will be housed in a red cryogenic dewar with a big white S on it. The articles will be mounted in a clean can with external electrical connectors and an optical port. The test articles will be subjected to appropriate tests, electrical and optical, that characterize the test articles.

4. Test Equipment

The optical testing will be at Stanford University in the detector acceptance test facility located in Cedar Hall, room 13. The following test equipment can be found there.

- 4.1 Calibrated Light Source NBS traceable, 100 W Lamp
- 4.2 Quadrupole Mass Spectrometer, SRS Model RGA100
- 4.3 TurboMolecular Vacuum Pump, Varian Model 300HT
- 4.4 Vacuum Readout Varian Digital Model Sentorr BA2C

5. Test Fixtures

A test fixture will be built to accommodate the test article, cabling and optical fixtures. The test fixture will be mounted on the Optical table to ensure accurate positioning and reproduceability for measurement of each DPA

- 5.1 Vibration Isolator Table, Newark Model RS1000
- 5.2 Calibrated Optical Filters, OCLI Catalog #Invisiglass

- 5.3 Calibrated Optical Filters, OCLI Catalog #340nm BP
- 5.4 Calibrated Optical Filters, OCLI Catalog #460nm BP
- 5.5 Calibrated Optical Filters, OCLI Catalog #550nm BP
- 5.6 Calibrated Optical Filters, OCLI Catalog #670nm BP
- 5.7 Calibrated Optical Filters, OCLI Catalog #850nm BP
- 5.8 Calibrated Optical Filters, OCLI Catalog #Quartz
- 5.9 Clean Test Dewar, IR Labs Model HDL-8, IR Lab S/N 3017
- 5.10 Clean Test Can, IR Labs Model NAHF14ZA
- 5.11 Neutral density filter, “Swiss Glass” 2”X3” microscope slide, Baxter Healthcare Corp. Cat # M6142.
- 5.12 Various optical component supports, baffles, and mirrors
- 5.13 Alignment telescope

6. Test Instrumentation

Hardware available to conduct the test are listed here. Items listed for tests are incorporated in the traveler with calibration information and GPB reference number.

6.1 Hardware

- 6.1.1 Photodiode, NBS traceable, Silicon. Serial #D213
- 6.1.2 Data logging system, Macintosh 9500 with LabView 4.1 software.
- 6.1.3 Readout Electronics Unit, Engineering Protoytp, Lockheed Model EU-003
- 6.1.4 Enginering Test Unit of the Warm Flight-like Telescope Readout Electronics with control computer.
- 6.1.5 Spectrum Analyzer, H-P Model 35567
- 6.1.6 Lamp Power Supply, H-P Model HP659B
- 6.1.7 Digitizing Oscilloscope, Tektronix Model 744A
- 6.1.8 Digitizing Oscilloscope, Tektronix Model 420A
- 6.1.9 Precision Digital Voltmeter H-P Model 3458A
- 6.1.10 Multiplexed Digital Voltmeter H-P Model 3457A
- 6.1.11 Voltage Calibration Source, Datel DVC-8500
- 6.1.12 Electrometer, Kiethley 6517
- 6.1.13 Capacitance Meter, Kiethley 595
- 6.1.14 Semiconductor Parameter Analyzer H-P Model 4156A

6.1.15 Multimeter Fluke Model 8842A, 2ea

6.1.16 Programmable Power Supply, H-P Model 6626A

6.1.17 HeNe alignment Laser, Hughes Model 3599H

6.1.18 Pyroelectric Power Meter, Laser Precision Model Rk-1500

6.1.19 Digitizing Oscilloscope, Tektronix Model 540A

6.2. Software

Software used to conduct the tests is described below.

6.2.1 Software Definition

LabView 4.1 virtual instrument (VI) data collection software will be written to control the test instruments and acquire the data. The Mac OS 7.5.3 and a PowerPC CPU Mac 9500/132 with National Instruments GPIB/PCI control card will be used.

A VI will be written for each test procedure and documentation generated to control the data collection procedure.

1. OpticalResponse.
This will control the testing procedure for the optical responsivity of the DPA.
2. Noise
This will control the testing procedure for the electronic noise level of the DPA.
3. LeakCurrent
This will control the testing procedure for the sense node leakage current of the DPA.
4. TemperatureTest

This will control the testing procedure for the heater control and power dissipation performance of the DPA.

5. PowerDissipation

This will measure the power dissipation of the DMA and the corresponding operating temperature.

5. ThermalStability

This will measure the preamplifier's temperature stability.

7. LakeShore

This will monitor the germanium thermometer during the test

8. RGA

This will monitor the vacuum system during the test.

6.2.2 Software Specification

1. OpticalResponse

The vi used will be: “*detector.vi single-ended*” which is based on single-ended output of the Engineering Readout and Control Electronics. This software will log the outputs of all four detector channel, XP, XN, YP, and YN. It will also log the two housekeeping channels with ground subtraction and be synchronized by the ATC Strobe.

2. Noise

The vi used will be: “*detector.vi differential*” which is based on the differential output of the Engineering Readout and Control Electronics. This software will log

the outputs of two of the four detector channel, XP and YP using the SIGHI and SIGLO readouts. It will also log the two housekeeping channels and be synchronized by the ATC Strobe.

3. LeakCurrent

The vi used will be: “*detector.vi differential*” which is based on the differential output of the Engineering Readout and Control Electronics. This software will log the outputs of two of the four detector channel, XP and YP using the SIGHI and SIGLO readouts. It will also log the two housekeeping channels and be synchronized by the ATC Strobe.

4. TemperatureTest

The vi used will be: “*detector.vi single-ended*” which is based on single-ended output of the Engineering Readout and Control Electronics. This software will log the outputs of all four detector channel, XP, XN, YP, and YN. It will also log the two housekeeping channels with ground subtraction and be synchronized by the ATC Strobe. The two housekeeping channels contain the essential information to measure the thermal parameters.

5. PowerDissipation

The vi used will be: “*detector.vi single-ended*” which is based on single-ended output of the

Engineering Readout and Control Electronics. This software will log the outputs of all four detector channel, XP, XN, YP, and YN. It will also log the two housekeeping channels with ground subtraction and be synchronized by the ATC Strobe. The two housekeeping channels contain the essential information to measure the thermal parameters.

6. ThermalStability

The vi used will be:

“detector.vi differential” which is based on single-ended output of the Engineering Readout and Control Electronics. This software will log the outputs of all four detector channel, XP, XN, YP, and YN. It will also log the two housekeeping channels with ground subtraction and be synchronized by the ATC Strobe. The two housekeeping channels contain the essential information to measure the thermal parameters.

7. LakeShore

The vi used will be:

“LakeShore.vi” which measures the output of the Germanium thermometer. *“LakeShore.vi”* is a subvi of *“detector.vi single-ended”* and *“detector.vi single-ended”*. The software will monitor the thermometer temperature as reported by the controller. No heater is connected to the heater control circuit.

8. RGA

The vi used will be: “*RGA Communication.vi, RGA command.vi, and Sentorr.vi*” which measures the output of the SRS RGA and Sentorr Vacuum sensor electronic readout module. The software will monitor the two thermocouples and the ionization gauge of the Sentorr unit and the most common gas species from the RGA, e. g., H₂O, O₂, N₂, CO₂, etc.

6.2.3 Software Configuration Control

Copies of the custom software will be filed with the document configuration control librarian of the GPB Project at Stanford University. Currently that person is Mae Sato. All changes made shall be documented and updated copies of the test software deposited with the librarian.

Software Inventory and Status

| Item # | Version | Name | Date Modified | Status |
|---------------|----------------|---|----------------------|-------------------------|
| 1 | 7.5.3 | Mac OS | 4/21/95 | Stable/Commercial |
| 2 | 4.1 | LabView for Mac | 12/31/97 | Stable/Commercial |
| 3 | 7.1.3 | GPIB Driver NI-488 | 2/17/97 | Stable/Commercial |
| 4 | 6.22 | DOS | 5/31/94 | Stable/Commercial |
| 5 | 3.4 | SQUID | 12/20/97 | Stable/Custom |
| 6 | 1.0 | OpticalResponse = “detector.vi single-ended” | 1/13/98 | Subject to modification |
| 7 | 1.0 | Noise = “detector.vi differential” | 1/14/98 | Subject to modification |
| 8 | 1.0 | LeakCurrent = “detector.vi differential” | 1/14/98 | Subject to modification |
| 9 | 1.0 | TemperatureTest = “detector.vi single-ended” | 1/13/98 | Subject to modification |
| 10 | 1.0 | Power Dissipation = “detector.vi single-ended” | 1/13/98 | Subject to modification |
| 11 | 1.0 | Thermal Stability = “detector.vi single-ended” | 1/13/98 | Subject to modification |
| 12 | 1.0 | LakeShore = “LakeShore.vi” | 1/13/98 | Subject to modification |
| Item # | Version | Name | Date Modified | Status |
| 13 | 1.0 | RGA = “RGA Communication.vi” and “RGA Command.vi” and “Sentorr.vi” | 1/13/98 | Subject to modification |
| 11 | 3.0.4 | KaleidaGraph | 6/17/94 | Stable/Commercial |

| | | | | |
|----|-------|-------------|---------|-------------------|
| 12 | 3.1 | Mathcad | 1/11/93 | Stable/Commercial |
| 13 | 3.5.4 | WordPerfect | 5/29.96 | Stable/Commercial |

6.3 Listed Equipment

Listed here are the Database Reference Numbers of equipment to be maintained in calibration for the purposes of testing in this program. The ETU is not listed because it is Ground Support Equipment which consists of separate components of unlisted equipment. Some of its components need calibration that is handled through internal calibration procedures, e. g., the A/D converter. The ETU oscilloscope is used for monitoring purposes only. The Mac/LabView data acquisition system is not listed as no calibration is possible or relevant. It logs data acquired by the Tek oscilloscopes and the LakeShore temperature controller.

Database Reference Numbers

| Item | S/N | DRN | Property Stanford/HEPL LockMar/HP NASA ARC | Calibration Certificate | Last Cal. Date |
|--|----------------------------------|-----|---|-------------------------------|----------------------|
| NIST 100 W tungsten filament calibration lamp GE 30/T24/13 | EPIR-1086 | | | NBS Special Publ. 250-1 | 1984 |
| NIST Silicon Photodiode Hamamatsu Model S2281 | S/N D213 | 61 | 911652 2/ 02195-2 | NIST844/ 257722-97 | 9/31/97 |
| Tek 744A Oscilloscope | B041929 | 60 | 911557 6/ 02119 | NASA ARC 365670 M112884 | 2/09/98 |
| Tek 420A Oscilloscope | B051297 | 64 | 911747 1/ HL02263-1 | NASA ARC 365669 M112883 | 2/09/98 |
| Tek 540A Oscilloscope | B011828 | 65 | LM/HP LP 014280 00/ 801229 | H1-21 GBTEA | 2/25/98 |
| Silicon Diode Thermometers | BC557T Philips Hamburg Slice #20 | 62 | Stanford University PO U3XD E487740 | Inst. Of Cryogenics | 7/96 |

| | | | | | |
|---------------------------------------|------------|----|-------------------------|-------------------------|---------|
| Germanium Resistor Thermometers | 23531-101 | | N/A | N/A | N/A |
| HP 3458A Multimeter | 2823A16067 | 57 | 902266 9/020447 | NASA ARC 365672 M112885 | 2/10/98 |
| LakeShore DRC93CA Controller | 17483 | 63 | NASA ARC 007217 | NASA ARC 365671 | 2/11/98 |
| Alignment Telescope Kueffel and Esser | 71 5180 | 71 | MPT 027152 00 7-7507-02 | Lockheed Y506 | 9/07/95 |

7. Required Tests

7.0.1. Illuminate the DPA photodiodes with a known quantity of optical radiation ~100 time greater than that of a bright star observable in flight at a wavelength of 670 nm. Measure the responsivity of the detectors to the radiation. If possible illuminate the photodiodes with a quantity of radiation similar to that anticipated by the actual guide star, nominally IM Peg. Measure the responsivity of one of the flight articles at wavelengths of 460, 550, 670, and 850 nm.. Measure the responsivity using the unapertured filament and with a small pinhole aperture

7.0.2. Measure the detector referred input noise across the frequency spectrum of 0 to 2500 KHz of the DPA detectors with and without optical radiation in the amount appropriate to 7.0.1.

7.0.3. Measure the leakage current of the detector input node without optical radiation at the anticipated flight operational temperature, nominally 80 K.

7.0.4. Measure the temperature stability of the DPA's DMA. Measure this in open loop and closed loop control using the DMA thermometer and housekeeping electronics.

7.0.5. Measure the power dissipation of the DPA's DMA. Measure this in closed loop control using the DMA thermometer

and housekeeping electronics. Measure the power dissipation of the DMA.

7.0.6. Measure Temperature Coefficient of Bias's dark current as in 7.0.3. This is accomplished by measuring the dark current at two temperatures differing by 10 K near the desired operating temperature..

7.0.7. Measure the Lateral Shift of the DMA alignment fiducial with respect to the DPA entrance aperture when cooled to LN₂ and LHe temperature.

7.1 Test Setup

Electrostatic discharge and overstress precautions will be adhered to as outlined in document P0357. Wrist-straps will be worn when making electrical connection to the dewar with the flight electronics. Wrist-straps will be worn then assembling the DPA and the clean can.

The DPA test article is to be mounted in the clean can of the clean dewar which is attached to the vibration isolation table via a mounting fixture with test equipment. The flight-like warm electronics will be connected. The Lakeshore Controller is to be connected to the dewar through one of the spare electrical connectors. The Engineering Test Unit rack will be connected. The Mac/LabView data system will be connected to necessary test equipment via the GPIB bus and the appropriate test equipment connected to the engineering rack. All grounds will be connected and checked. Equipment will then be turned on and allowed to stabilize. The optical source will be turned on and calibration checked with the calibrated optical radiation detector.

The LakeShore controller is to monitor the Ge thermometer continually. The RGA and Varian Sentorr Units are to monitor the vacuum throughout the test. By the way, there is a room temperature thermometer mounted on the room wall.

7.1.1 Test Environment

The DPA test article will be mounted in a clean can in a clean room of cleanliness class 100. It shall remain in the clean can for the duration of the test and be delivered for integration while confined to the clean can. The clean can consists of machined aluminum structure with a glass window and hermetically sealed electrical connections to the external environment. A porous plug will be incorporated to evacuate the clean can and filter any particulate material.

The clean can will be mounted in a clean test dewar. The cleanliness level of the test dewar will be class 10,000. A turbomolecular pump will be used to evacuate the dewar in order to minimize contamination by pump oils.

The test dewar will be used in a normal laboratory environment of no specified cleanliness class. The dewar will be mounted on an standard optical table on which the test beam of light is generated and injected into the dewar window; and thereby into the clean can window; and thereby into the DPA. Normal room temperature and humidity will be suitable for this experiment.

7.1.2 Test Setup Checklist & History

| Step # | Title | Date & Operator | QA Rep |
|--------|---|-----------------|--------|
| 1 | Vacuum System Running Dewar Vacuum Monitors Thermocouple #1 Thermocouple #2 Ionization Gauge RGA | | |
| 2 | Dewar on test stand | | |
| 3 | Connect Vacuum system | | |
| 4 | Open vacuum valve to Pump | | |
| 5 | Open vacuum valve to Dewar | | |
| 6 | Wrist strap on | | |
| 7 | ETU off | | |
| 8 | Connect ETU Cables A & B | | |
| 9 | Connect LakeShore Cable | | |
| 10 | Power up ETU | | |

| | | | |
|----|--|--|--|
| 11 | Power up Lakeshore | | |
| 12 | Connect Mac/Labview/Tek scopes to ETU patch panel | | |
| 13 | Check detector operation warm | | |
| 14 | Start to Record ramp & housekeeping data with Mac/Labview/Tek | | |
| 15 | Wait at least 2 hours | | |
| 16 | Optically measure the position of the Detector fiducial with respect to the DPA Aperture before cooling. | | |
| 17 | Agree on readiness to cool | | |
| 18 | Make a Recording of ramp & housekeeping data with ETU | | |
| 19 | Liquid N ₂ fill | | |
| 20 | Adjust balancing during cool | | |
| 21 | Continue to Record ramp & housekeeping data with Mac/Labview/Tek | | |
| 22 | Wait at least 3 hours | | |
| 23 | Optically measure the position of the Detector fiducial with respect to the DPA Aperture before cooling. | | |
| 24 | Agree on readiness to cool | | |
| 25 | Make a Recording of ramp & housekeeping data with ETU | | |
| 26 | Liquid He fill | | |
| 27 | Adjust balancing during cool | | |
| 28 | Continue to Record ramp & housekeeping data with Mac/Labview/Tek | | |
| 29 | Wait at least 3 hours | | |
| 30 | Optically measure the position of the Detector fiducial with respect to the DPA Aperture. | | |
| 31 | Make a Recording of ramp & | | |

| | | | |
|----|--|--|--|
| | housekeeping data with ETU | | |
| 32 | Start tests of responsivity | | |
| 33 | Start large aperture filament test of responsivity | | |
| 34 | Conclude large aperture filament test of responsivity | | |
| 35 | Start small aperture filament test of responsivity | | |
| 36 | Conclude large aperture filament test of responsivity | | |
| 37 | Conclude test of responsivity | | |
| 38 | Start test of leakage current | | |
| 39 | Conclude test of leakage current | | |
| 40 | Start test of noise | | |
| 41 | Conclude test of noise | | |
| 42 | Start test of temperature stability | | |
| 43 | Conclude test of temperature stability | | |
| 44 | Start test of power dissipation | | |
| 45 | Conclude test of power dissipation | | |
| 46 | Start test of temperature coefficient of bias | | |
| 47 | Conclude test of temperature coefficient of bias | | |
| 48 | Optically measure the position of the Detector fiducial with respect to the DPA Aperture before warming. | | |
| 49 | Agree on conclusion of tests | | |
| 50 | Make a Recording of ramp & housekeeping data with ETU | | |
| 51 | Begin to warm up dewar | | |
| 52 | Vacuum System Running Dewar Vacuum Monitors Thermocouple #1 Thermocouple #2 Ionization Gauge | | |

| | | | |
|----|---|--|--|
| | RGA | | |
| 53 | Record Thermometers Ge Thermometer Si Diode #1 Si Diode #2 | | |
| 54 | Close vacuum valve to Pump | | |
| 55 | Close vacuum valve to Dewar | | |
| 56 | Wait for temperature to attain 310 K on the detector Platform | | |
| 57 | Optically measure the position of the Detector fiducial with respect to the DPA Aperture before cooling. | | |
| 58 | Disconnect Vacuum system | | |
| 59 | Bleedup Dewar vacuum pressure | | |
| 60 | Dismount Dewar | | |

7.2 Optical Responsivity Test Criteria

Optical responsivity tests are intended to determine if the detectors of the DPA assembly have an external optical quantum efficiency of at least 70 %. The following guideline is to be used:

Table 7A
Optical Responsivity Test Criteria

| | |
|------------------------|----------------------|
| Wavelength | 550 nm |
| Input Optical Flux | 70,000 photons/sec |
| Star | IM Peg |
| Preamp Reset Rate | 10 Hz |
| Minimum Output Current | 49,000 electrons/sec |

7.3 Input Referred Noise Test Criteria

The DPA test article is to have the output noise level of the readout electronics measured and scaled to reflect the system gain. The input referred readout noise in the absence of light is not to exceed the values in table 7B in the frequency ranges specified when exercised by the TRE warm electronics.

The noise spectral specifications have been translated into units of e^-/read for inclusion in PLSE-13, Pt 3.

Table 7B
Input referred noise measurement Criteria

| | |
|---------------|---------------------|
| Maximum Noise | 50 e^- rms/(read) |
|---------------|---------------------|

7.4 Input Leakage Current Test Criteria

The DPA test article is to have the output voltage ramp of the readout electronics measured and scaled to reflect the system gain. The input referred leakage current in the absence of light is not to exceed the values in

table 7C in the reset period of 100 ms when exercised by the TRE warm electronics.

Table 7C
Input Referred Leakage Current Measurement Criteria

| | |
|-------------------------|-------------------------|
| Maximum Leakage Current | 10 aA @ T _{op} |
|-------------------------|-------------------------|

7.5 Temperature Stability Test Criteria

The DPA test article is to be allowed to operate in an uncontrolled temperature stability test. Then DPA test article is to have the closed loop thermal control applied. The controlled temperature stability is expected not to exceed the value in table 7D.

Table 7D
Temperature Stability Test Measurement Criteria

| | |
|---------------------------|------------------------|
| Maximum Temperature Drift | T _{op} ± 2 mK |
|---------------------------|------------------------|

7.6 DMA Power Dissipation Test Criteria

The DPA test article is to be allowed to operate at a stable uncontrolled operating temperature, 80 K ± 20K. Then DPA test article is to have the closed loop thermal control applied. The power dissipation is expected not to exceed the value in table 7E.

Table 7E
DMA Power Dissipation Test Measurement Criteria

| | |
|---------------------------|---------------------------|
| Maximum Power Dissipation | <1.5 mW @ T _{op} |
|---------------------------|---------------------------|

7.7 Temperature Coefficient of Pointing Bias of the Preamplifier Test Criteria

The DPA test article is to be allowed to operate at a stable uncontrolled operating temperature, 80 K \pm 20K. Then DPA test article is to have the closed loop thermal control applied. The power dissipation is expected not to exceed the value in table 7F.

Table 7F
DMA Temperature Coefficient of Pointing Bias Measurement Criteria

| | |
|--|---|
| Maximum Temperature Coefficient of Pointing Bias | $< 440 \text{ e}^-/(\text{read})\text{K}$ |
|--|---|

7.8 Thermal Alignment, Decentering, Measurement Criteria

The DPA test article is to operate stably at approximately 310, 90 K and <10 K. That is power dissipation is to be minimal during this test at the Liquid Helium temperature. The thermally induced decentering is expected not to exceed the value in table 7G.

Table 7G
Thermal Alignment, Decentering, Measurement Criteria

| | |
|---------------------|--------------------------------|
| Maximum Decentering | $\pm 500 \text{ } \mu\text{m}$ |
|---------------------|--------------------------------|

8. Measurements

The following is a description of the measurement procedures for each of the parameters listed in Section 7. You must have a copy of the ETU operation manual and an approved operator of that equipment. Be sure to have completed all steps in the table of section 7.1.2 the Test Setup Checklist & History that precede commencement of testing. The detector thermometer should be operating at 80 K \pm 10 K except where the procedure requires a different temperature.

8.1 General Description

Measurements of the Optical Responsivity are to be taken for a minimum time period of 5 minutes, sustained illumination. This measurement is to be repeated a minimum of 10 times using a shutter at alternating periods of 5 minutes. The measurement will be made by peaking the beam of light in the

X-Y, q, w coordinates of the detector plane. The image of the lamp filament will be larger than the detector area, the detector being of dimension 0.5 mm.

Measurement of the electrical noise level of the detector readout will be made continuously and sampled periodically over a period of 1 hour. Independent spectra gathered at random times shall total no less than 30 in number.

Measurement of the leakage current will be made by averaging the difference of detector pairs until sufficient time has passed to measure 10 aA with a minimum S/N of 10.

Measurement of Temperature Stability will be made over a minimum period of 1 hour. A sufficient number of samples will be collected to measure, with a S/N better than 10. Drift shall not exceed ± 2 mK.

The power dissipation is to be logged during operation of the stability tests, but will extend the range of temperatures measured from 70 to 90 K.

Measurement of the temperature coefficient of bias will be made by averaging the difference of detector pairs until sufficient time, estimated to be one hour, has passed to measure $440 \text{ e}^-/(\text{read})\text{K}$ with a minimum S/N of 10.

All tests are to be conducted at 70, 80, and 90 K.

8.2 Control Points

Each test procedure will incorporate calibration checks on the optical and electrical equipments. Optical calibration will be accomplished by the measurement of the light source with a calibrated detector. Voltage calibration will be checked with a precision calibrated voltage source. Calibration certificates will be obtained and records kept of the instrumentation used in each test. A qualified representative of the quality control representative should be present during each test procedure.

8.3 Test Procedure

Detailed test procedures are given here for each of the tested parameters. It is assumed that the testing is done sequentially. If not, then the setup

instructions of Section 8.3.1, with the exception of the lamp warmup, apply to all tests.

8.3.1 Optical Responsivity

Slowly warm up the tungsten filament calibration lamp by increasing the lamp supply current to 40.00 A. The power supply should be set to regulate to constant current. Periodically monitor the lamp supply voltage at the lamp base and record the result in the log book. Wait for a period of at least 3 hours for the lamp to stabilize before collecting valid data.

Balance the currents in the JFET pairs using the procedure “Balancing the TRE Detector Modules” in the ETU module. Record the Oscilloscope voltage scales and the ETU CLAMP and OFFSET settings.

Check the alignment of the optical system with the HeNe alignment laser so that the laser beam illuminates the alignment fiducial. Adjust the optical components so as to illuminate the fiducial. Record any adjustments.

Turn off the laser and examine the color of the tungsten filament by looking down the optical train. Record the color.

Insert the optical filter in front of the baffle tube with a black foam spacer to seal light leaks.

Examine the color of the tungsten filament by looking down the optical train. Record the color.

Tilt the dewar in the q, w directions to illuminate one of the detector pixels, either the X or Y pixel. Peak up the signal. Measure the tilt angle with the inclinometer and the position angle. Record the result.

Go back and check that the ETU Clamp has not drifted. If it has, then you did not wait long enough after the liquid helium fill. Kick yourself and record the result in the log book.

Using an opaque shutter, make and break the optical beam with a period of 10 minutes and a 50/50 duty cycle. This should continue for a period of time not less than 1 hour. Record the value of the mean slope from the Mac

data logging system. Note any drifting or spiking or inadvertent interruptions in the data taking sequence. Such events are not necessarily cause to abort the testing. Check with the test director when such circumstances arise.

Tilt the dewar to illuminate one of the other pair of detector pixels, either the Y or X pixel. Peak up the signal. Measure the tilt angle with the inclinometer and position angle. Record the result.

Go back and check that the ETU Clamp has not drifted. If it has, then you did not wait long enough after the liquid helium fill. Kick yourself and record the result in the log book.

Using an opaque shutter, make and break the optical beam with a period of 20 minutes and a 50/50 duty cycle. This should continue for a period of time not less than 2 hours. Record the value of the mean slope from the Mac data logging system. Note any drifting or spiking or inadvertent interruptions in the data taking sequence. Such events are not necessarily cause to abort the testing. Check with the test director when such circumstances arise.

The recorded slope is in V/sec. The conversion factor to quantum efficiency is $(3.62 \times 10^6 \text{ e-/sec}) / (1.11 \times 10^7 \text{ ph/sec}) = 0.326 \text{ e-/ph per V/sec}$ of slope. This is shown in the Mathcad document: *Lamp Emission GPB*. A number of assumptions and measurements are taken into account knowing the optical setup and components. So if anything changes, you better record it and measure it. The optical setup is referred to as the setup for good reason.

Repeat the procedure at temperatures of 80 and 90 K. You don't have to wait 3 hours for the dewar to stabilize. Just enter a new parameter into DTEMP.

Now change the optical setup by placing the pinhole aperture at the lamp filament so that the detector signal is maximized. Repeat the measurement procedure above at a temperature of 80 K. You should expect to receive a lot less signal in proportion to the arial ratio of the filament projected on the detector to the pinhole area, taking into account the magnification of the lens.

8.3.2 Electrical Leakage Current

Block the optical beam completely at the baffle tube entrance and check for optical leaks around the dewar using a flashlight. Correct as necessary. Note any corrections and record the results in the log book. The electrical leakage tests are ready to test when no discernable signal can be detected from the flashlight.

Set the Engineering Test Unit control command to 1500 for each of the DMAs under test and center the output of the detector amplifiers so that they are midrange and stable. Record the Oscilloscope voltage scales and the ETU CLAMP and OFFSET settings.

Record the value of the mean slope from the data logging system. This is in V/sec. The conversion factor to leakage current is 3.62×10^6 e-/sec per V/sec of slope.

Repeat the procedure at temperatures of 80 and 90 K. You don't have to wait 3 hours for the dewar to stabilize. Just enter a new parameter into DTEMP.

8.3.3 Noise

Block the optical beam completely and check for optical leaks using a flashlight. Correct as necessary. Note any corrections and record the results in the log book. The electrical leakage tests are ready to test when no discernable signal can be detected from the flashlight.

Balance the currents in the JFET pairs using the procedure "Balancing the TRE Detector Modules" in the ETU module.

Set the Engineering Test Unit CONTROL word for the X and Y channels to 1500. Record the Oscilloscope voltage scales and the ETU CLAMP and OFFSET settings.

Set the Temperature reference of the Engineering Test Unit, DTEMP command, so as to bring the temperature servo-amplifier output into range and approximately center it. Choose a temperature of 70 K. Look up the setting for the temperature command word on the ETU. Engage the local temperature control servo with the ETU.

Record the value of the mean slope, and the standard deviation of the slopes and the variance of the slopes. The conversion factor to current is 3.62×10^6 e-/sec per V/sec of slope. One read of the TIA corresponds to 100 ms. 10 e-/sec corresponds to 1 e-/read.

Repeat the procedure at temperatures of 80 and 90 K. You don't have to wait 3 hours for the dewar to stabilize. Just enter a new parameter into DTEMP.

8.3.4 Temperature Stability of the DMA

When the dewar is thermally stabilized for no less than 3 hours after filling with liquid helium, the test may commence.

The RGA vacuum monitor must be running during the observation period. The dewar vacuum valve must be open so as to exhaust the vacuum space to the RGA and turbomolecular pump

Set the Temperature reference of the Engineering Test Unit, DTEMP command, so as to bring the temperature servo-amplifier output into range and approximately center it. Choose a temperature of 70 K. Look up the setting for the temperature command word on the ETU. Engage the local temperature control servo with the ETU.

Balance the currents in the JFET pairs using the procedure "Balancing the TRE Detector Modules" in the ETU module.

Begin logging data for a period of at least one hour. During the observation period, the temperature servo-amplifier must not require recentering.

The recorded values of the temperature servo-amplifier should be scaled by the gain corrected voltage sensitivity factor $(-576.6/227.27)$ K/V = 2.537 K/V. This is the differential data collection program. For the single ended case the factor is 5.17 K/V.

Repeat the procedure at temperatures of 80 and 90 K. You don't have to wait 3 hours for the dewar to stabilize. Just enter a new parameter into DTEMP.

8.3.5 Power Dissipation

When the dewar is thermally stabilized for no less than 3 hours after filling with liquid helium, the test may commence. The power dissipation will be logged by the computer. The bias voltages and heater voltage reported by the housekeeping channel of the TRE forward electronics are used calculate the dissipation.

Turn off the current to the JFETs, which is the same as tuning off the detector power enable on the ETU.

Choose a temperature of 70 K. Look up the setting for the temperature command word on the ETU, and enter specified HEX value from table in the ETU manual. Engage the local temperature control servo with the ETU. All the time you should be recording data with the Mac/LabView system. Wait 20 minutes and choose another temperature of 50 K. Repeat the process until in 10 K increments until 110 K is achieved.

Repeat the procedure at temperatures of 80 and 90 K. You don't have to wait 3 hours for the dewar to stabilize. Just enter a new parameter into DTEMP.

8.3.6 Temperature Coefficient of Pointing Bias

When the dewar is thermally stabilized for no less than 3 hours after filling with liquid helium the test may commence.

Choose a temperature of 70 K. Look up the setting for the temperature command word on the ETU. Engage the local temperature control servo with the ETU. Set the Temperature reference of the Engineering Test Unit, DTEMP command, so as to bring the temperature servo-amplifier output into range and approximately center it.

Block the optical beam completely at the baffle tube entrance and check for optical leaks around the dewar using a flashlight. Correct as necessary. Note any corrections and record the results in the log book. The electrical leakage tests are ready to test when no discernable signal can be detected from the flashlight.

Set the Engineering Test Unit control command to 1500 for each of the DMAs under test and center the output of the detector amplifiers so that they

are midrange and stable. Record the Oscilloscope voltage scales and the ETU CLAMP and OFFSET settings.

Record the value of the mean slope from the data logging system. This is in V/sec. The conversion factor to leakage current is 3.62×10^6 e-/sec per V/sec of slope.

Repeat the procedure at temperatures of 80 and 90 K. You don't have to wait 3 hours for the dewar to stabilize. Just enter a new parameter into DTEMP.

Record the values of the mean slope from the data logging system. This is in V/sec. The conversion factor to leakage current is 3.62×10^6 e-/sec per V/sec of slope.

8.3.7 Thermal Alignment Shift, Decentering

At room temperature, liquid nitrogen temperature, and liquid helium temperature, use the alignment telescope to determine the position of the alignment fiducial on the detector chip with respect to the entrance aperture of the DPA. This test can be accomplished during the initial cooldown and repeated, reversed in temperature change rate, upon warmup.

Insert the pellicle beamsplitter into the optical beam. Remove the filter from the optical beam.

With the calibration lamp illuminating the DPA entrance aperture as in the responsivity tests, adjust the illumination intensity with apertures or reflectors for appropriate contrast so as to make the detector alignment fiducial observable with the alignment telescope.

Measure the relative position of the fiducial with respect to the DPA. Record the result. Make three independent measurements. Restore the responsivity measurement setup for further measurements. Repeat as often as necessary.

9. **Data Collection**

Data will be collected and a test record kept of measurements and data files. It is essential that time of collection be recorded. A computerized record of the test article performance will be kept by the Engineering Test Unit and the Mac/LabView Data logging system. Each DPA will have a separate and individually titled notebook that will become the official record of the testing. A traveler will record the history of test article handling. Serial numbers and calibration dates of all measurement equipment used to characterize the test article will be recorded. Test articles will have all relevant identification numbers recorded in the Traveler that will uniquely identify the test article.

9.1 **Data Format**

Data will be collected and a test record kept of measurements and data files. The files will be written in ASCII format and the file will be in spreadsheet format that is compatible with Kalidagraph 3.0.

Three files folders will be generated for each measurement session. These folders will be stored in a separate folder labeled with the DPA # in the Mac File system.

9.1.1 **A file for Header**

The Header file will record the housekeeping measurements, the measured level of a single ramp, the measured slope of the ramp, and a single measured squared error of a single ramp fit to a linear ramp or each of the detectors. This is the same ramp that is recorded in the Frame file. Other pertinent measurements like the time of day will be recorded in this file. The time stamp of the Frame file is recorded here. The LakeShore Controller temperature reading from the Ge thermometers goes here

9.1.2 **A file for Mean.**

The Mean file will contain the mean level of the ramp, the mean slope of the ramp, and the mean squared error of the ramp fit to a linear ramp for a series of 100, or other chosen number, readings of the oscilloscope or each of the detectors.

9.1.3 A file for Frame

The Frame file will contain the digitized signal of the ramp waveform for each of the detectors for the first ramp in each of the series of 100 ramps that are acquired in the mean file. This is repeated until the stop number 1000, or other chosen number, is attained. The time stamp of the Frame file is entered into the Header file

9.1.4 A file for RGA output

The RGA output file has a record of the vacuum system during the data collection procedures. It is required for diagnostic purposes.

10. Pass-Fail Criteria

Failure is based on performance limits derived from the system design through a model of the telescope control system.

- 1) The optical quantum efficiency shall be greater than 70 %
- 2) The noise level shall be less than 50 e⁻ rms/read.
- 3) The leakage current shall be less than 10 aA in each frequency range.
- 4) The temperature stability shall be less than 2 mK over the period of an hour.
- 5) The power dissipation shall be less than 1.5 mW per DMA, or 3.0 mW per DPA.
- 6) The temperature coefficient of bias of the detector circuit shall be less than 440 e⁻/(read)/K
- 7) The thermal shift in alignment, the decentering, shall be less than 500 μm

DPA's that do not meet these specifications shall have a discrepancy report prepared, reviewed and approved with the disposition of the DPA recorded.

11. Qualified Personnel

11.1 Test Director

The qualified test director is Paul Ehrensberger, the Integrated Product Team Manager of the Telescope Readout Electronics (TREIPTL).

11.2 Qualified Test Personnel

| Equipment | Personnel |
|-----------------------|---|
| Macintosh Data System | Ali Kashani, John Goebel |
| Data Analysis | Dave Meckfessel |
| Engineering Test Unit | Bob Fujimoto, Howard Demroff, Bob Farley, Paul Ehrensberger |
| Optics and Alignment | John Goebel |
| Cryogenics | Gene Tam, John Goebel, Paul Ehrensberger, |
| Vacuum Equipment | John Goebel, Nick Scott, Ali Kashani |
| Oscilloscopes | Howard Demroff, Ali Kashani, John Goebel |
| Optical Alignment | Mark Sullivan, Jeff Young, John Goebel |

11.3 Quality Control Personnel

A quality control witness will be present during testing. The Quality Control Representative, Ben Taller, or his duly appointed representative, Ken Coleman, will be present at the commencement of testing of flight articles, and during the testing of each flight article until the completion of testing.

11.4 Government Mission Assurance Representative

The government mission assurance representative testing, Ed Ingraham from Office of Naval Research, will be notified at least 48 hours prior to the commencement of testing of flight articles.

12. **Test Report**

A test report describing test preparation, conduct, data and results will be written and submitted for inspection. The software used to analyze and write the report is specified in section 6.2.3. The handling history will be recorded in section 13.1 and accompany the part as the traveler. The test results will be summarized in section 13.2. Any test discrepancies will be noted in section 13.3.

13. Certificates

13.1 Test Certificate Completion and Acceptance

A test certificate announcing compliance with the certified test procedures will be submitted with a signoff sheet for authorized approvals.

Gravity Probe B Relativity Mission

Detector Package Assembly

Test Completion and Acceptance Certificate for DPA # _____

| DPA | S/N | Rev |
|-----|-----|-----|
| | | |

Approval:

John H. Goebel
Telescope Readout Electronics Responsible Engineer

Date

Paul D. Ehrensberger
Telescope Readout Electronics Integrated Product Team Leader

Date

Ben Taller
Quality Engineer

Date

Bob Schultz
Chief System Engineer

Date

John P. Turneure

Date

Hardware Manager

13.2 Test Compliance with PLSE 13, Pt. 3

This document certifies that the test article has been tested in accordance with PLSE 13, pt. 3. The relevant paragraphs are listed and compliance with the pass/fail criteria noted.

| | | |
|-----|-----|-----|
| DPA | S/N | Rev |
| | | |

DPA Requirements (extracted from TRE Spec [PLSE-13 Pt 3])

| Paragraph | Title | Pass/Fail |
|-----------|---|-----------|
| 3.2.5.3 | Platform Temperature, Variation at Roll Frequency | |
| 3.2.6.1 | DPA Power Dissipation | |
| 3.2.18.1 | External Quantum Efficiency at 400 to 900 nm wavelength | |
| 3.2.18.2 | External Quantum Efficiency at 550 nm wavelength | |
| 3.2.18.3 | I_Dark | |
| 3.2.18.4 | Diameter of Photoactive Area | |
| 3.2.18.7 | Operating Temperature (Si JFETs) | |
| 3.2.18.7 | Random Noise | |
| 3.2.18.8 | Temperature Coefficient of Bias | |

13.3 Traveler

The history of handling the DPA during the testing will accompany the test article. Handling procedures will be reported in the traveler.

| DPA | S/N | Rev |
|-----|-----|-----|
| | | |

| Station | Action | Condition | Handler | Date |
|-------------------------------------|--------|-----------|---------|------|
| DPA receipt | | | | |
| DPA incorporation into clean can | | | | |
| Clean Can incorporation into dewar | | | | |
| Dewar incorporation into Test Setup | | | | |
| Dewar disassembly | | | | |
| Clean Can disassembly | | | | |
| DPA extraction | | | | |
| DPA delivery | | | | |

13.4 Test Results and Summary

Test Article Identification

| | | |
|---------|-----|-----|
| DP A | S/N | Rev |
| | | |

| | | | | | | | |
|------------------------|--|--|--|--|--|--|--|
| Start Date | | | | | | | |
| Completion Date | | | | | | | |

| | |
|---------------------------|--|
| Magnetic Screening | |
| Date | |
| Pass/Fail | |

| | |
|----------------|----------------|
| DMA # | DMA# |
| Cable # | Cable # |
| CAP # | CAP # |

Measurement Equipment & Calibration

| Item | Manufacture & Model | Calibration Date | Database Reference Number |
|--------------------------|--------------------------------|-------------------------|----------------------------------|
| Lamp | | | |
| Photodiode | | | |
| Oscilloscope | | | |
| Oscilloscope | | | |
| Optical Filter | | | |
| Optical Filter | | | |
| Optical Filter | | | |
| Optical Filter | | | |
| Alignment Telescope | | | |
| ETU | | | |
| Temperature Readout Unit | | | |

Test Results

| Procedure | Measure | Error | Criteria | Operator & Date | Pass & Fail |
|--|---------|-------|--|-----------------|-------------|
| Quantum Efficiency | | | $\geq 70 \%$ | | |
| Leakage Current | | | $< 10 \text{ aA}$ | | |
| Noise | | | $< 50 \text{ e}^- \text{ rms/read}$ | | |
| Power Dissipation | | | $< 1.5 \text{ mW}$ | | |
| Temp Stability | | | $T_{\text{op}} \leq 2 \text{ mK}$ | | |
| Alignment Shift | | | $Z_0 \leq 500 \text{ } \mu\text{m}$ | | |
| Temperature Coefficient of Pointing Bias | | | $< 440 \text{ e}^- / (\text{read}) / \text{K}$ | | |

13.5 Test Discrepancies

Test Discrepancies

| Procedure | Discrepancy | Operator/Date |
|------------------|--------------------|----------------------|
| | | |
| | | |
| | | |
| | | |
| | | |

13.5 Bias Test Report

ETU Controllable Parameters That Affect Telescope Pointing Bias Variation

| Controllable Parameter | TRE ETU Command Parameter | ETU Input Test Signal | TRE ETU Input Command Address Range | | ETU Output Signal |
|----------------------------|---------------------------|-----------------------|-------------------------------------|------------|-------------------|
| | | | Voltage Limits | Hex Limits | |
| Name | Name | (V/sec) | | | (V/sec) |
| + Direction Clamp Voltage | CLAMP | | | 00_FF | |
| - Direction Clamp Voltage | CLAMP | | | 00_FF | |
| ▒ Direction Clamp Voltage | CLAMP | | | 00_FF | |
| +Reference or Reset Level | SBIAS (OFFSETS) | | | 00_FF | |
| -Reference or Reset Level | SBIAS (OFFSETS) | | | 00_FF | |
| ▒ Reference or Reset Level | SBIAS (OFFSETS) | | | 00_FF | |
| Diode Bias Voltage | PBIAS (BIAS) | | | 00_FF | |
| Heater Voltage | HEAT | | | 00_FF | |
| Control | CONTROL | | | N/A | N/A |

14. Disposition of materials and discrepancies

Tested parts will be delivered to the integration product team for incorporation in the Science Probe or storage in an appropriate secure clean facility. Rejected parts will be dealt with as required by Quality Plan P0108. Any discrepancies will be reported in the traveler and data report.

15. **Safety**

Qualified laboratory personnel will conduct these tests. They are required to have undergone laboratory safety training and be up to date. The HeNe laser is class IV, so formal training is not necessary. The optical setup will capture reflected laser beams to avoid injury concerns, either real or imaginary. Experience with handling high pressure gas cylinders and cryogenic fluids is necessary. Safety training for falling objects in case of earthquake is necessary. Safety training in handling of electrical and electronic equipment is necessary.

Appendix A

Detector Package Assembly Verification Matrix

Telescope Readout Electronics Specification PLSE-13 Part #3

| Paragraph | Title | Text & Comments | Method | Verification Plan | √ |
|-----------|---|--|--------------|---|---|
| 3.2.5 | Telescope Detector Mount Assembly | See attached Doc. Text File for an overview of this section. | | | |
| 3.2.5.1 | First Natural Resonance Vibration Environment | $f_0 \geq 100$ Hz Protoqual @ LN ₂ 77K | S,T | P0358 DMA vibration test procedure S-Doc TBS | |
| 3.2.5.2 | Detector Alignment w.r.t Focused Image Position | | | | |
| 3.2.5.2.1 | Pitch/Roll/Tilt Yaw | ≤ 5 degrees ≤ 10 arcmin ≤ 30 arcmin | I,F | Inspect vendor data | |
| 3.2.5.2.2 | Defocus | ≤ 200 micrometers ≤ 500 μ m | I,F | Inspect vendor data | |
| 3.2.5.2.3 | Decenter | ≤ 100 μm ≤ 500 μ m | I,F | Inspect vendor data | |
| 3.2.5.3 | Platform Temperature Variation at Roll Frequency, as defined in T003, 7.6.2 | ≤ 2 mK | A,T | Payload level verification | |
| 3.2.5.4 | Number of Electrical Leads | 20 | I | P151-Detector-Mount-Subassembly-Inspection | |
| 3.2.5.5 | Electrical Lead Resistance | ≤ 100 Ω | A,T | P151- Detector Mount Subassembly Build | |
| 3.2.5.6 | Base Temperature | | | | |
| 3.2.5.6.1 | Base Operational Temperature | 2-6 K | T | P0392: Duration of testing | |
| 3.2.5.6.2 | Base Test Temperature | 2 - 290 K | T | P0392: Duration of testing | |
| 3.2.5.6.3 | Base Bakeout Temperature (survive) | 340 K | N/A | P0151 | |
| 3.2.5.7 | EMI | TBD | F | EMI test booth and GTU 2 | |
| 3.2.6 | Detector Thermal Output | | | | |
| 3.2.6.1 | Total Telescope | 4 mW (1 mW /platform) | A,T | P392: Power | |

| | | | | | |
|---------|--|------------------------|------|--|--|
| | Detector Power (All Detectors) | 6 mW (1.5 mW/platform) | | Dissipation Test | |
| 3.2.7 | Detector Base Operational Temperature Range | | | | |
| 3.2.7.1 | Operational Temperature range at 10 fA, 10 pA, and 1 microAmp Photo Current Levels | 6K - 2K | FN/A | Testing in cryo-telescope facility and GTU 2 S-Doc TBS Header | |
| 3.2.7.2 | Operational Temperature Range at 10 pA Current Level | 300K - 2.0 K | FN/A | Testing in cryo and room temperature-telescope facilities S-Doc TBS Header | |

| | | | | | |
|----------|---|---|-------|--|--|
| 3.2.13 | Telescope to Telescope Detector Interface | <p>Large Picture available in Doc. Text File.</p> <p>Assuming:</p> <ul style="list-style-type: none"> 65-50% Strehl ratio 0.4 - 1.0 micron wavelength >=70% photons shall fall on the detector 53-21% transmission efficiency -/+ 60 arcsec ST field of view Worst case Guide Star (V711 TAURI) 80% photodetector efficiency Expected photo-current = 12 fA per detector when telescope is centered Minimum Scale Factor $\geq 18 * 10^{(-18)}$ Amp/marcsec per detector | A | | |
| 3.2.18 | TRE Detector Performance Requirement | | | | |
| 3.2.18.1 | External Quantum Efficiency at 400 to 900 nm wavelength | >70% | S,A,T | P0392: Optical Responsivity test one flight unit will be tested over several wavelength and use similarity for other flight units. S-Doc TBS | |

| | | | | | |
|-----------|---|--|-------|--|--|
| 3.2.18.2 | External Quantum Efficiency at 550nm wavelength | >70% 80 % | A,T | P0392: Optical Responsivity test | |
| 3.2.18.3 | I_Dark | <0.01 fA @ $T_{op} 80$ K | A,T | P0392: Electrical Leakage Current Test Measure w/o light and at $V_{detB}=4.0V$ @ $T_{op} 80$ K | |
| 3.2.18.4 | Diameter of Photoactive Area | TBD (.5 to .8 mm) 0.8 mm | I,A,T | P332 | |
| 3.2.18.5 | Sense Node Capacitance | <20 pF | A,T | P0392 | |
| 3.2.18.6 | Operating Temperature (Si JFETs) | 40 K < T_{op} < 120 K 80 K ± 10 K | A,T | P0392 : Temperature Stability Test Measure without light and at $V_{detB}=4.0V$ @ 80 K with all components | |
| 3.2.18.7 | Sense Node Referred Random Noise | <50 e rms/(0.1 sec read) | A,T | P0392: Noise test | |
| 3.2.18.8 | Temperature Stability | <440 e/(read)/K | A,T | P0392: Temperature coefficient of Stability Test | |
| 3.2.18.8 | Transistor Gain | > .3 E 3 mhos | A,T | Measure without light and at $V_{DetB} = 4.0 V$ @ T_{op} | |
| 3.2.18.9 | Transistor Gain Matching | <5% | A,T | Measure without light and at $V_{DetB} = 4.0 V$ @ T_{op} | |
| 3.2.18.10 | Vgs Matching | <1% | A,T | Measure without light and at $V_{DetB} = 4.0 V$ @ T_{op} | |
| 3.2.18.11 | Vgs Temperature Coefficient Matching | <1% | A,T | Measure without light and at $V_{DetB} = 4.0 V$ @ T_{op} | |

Appendix B

Detector Package Assembly Requirements Verification Documents Checklist

Detector Package Fabrication & Assembly

| Document | Revision Date | Author | Title | Written | In Database | Approval Status | Dwg Ref | Flow Ref | Verif Ref |
|----------|---------------|-----------------|--|---------|-------------|-----------------|---------|----------|-----------|
| P0151 | 11/26/97 | P. Ehrensberger | Procedure for Detector Package Assembly Fabrication | √ | | Approved | √ | √ | √ |
| P0219 | 5/19/97 | P. Ehrensberger | Telescope Detector Circuit Assembly Fabrication | √ | N/A | Approved | | √ | |
| P0332 | 11/18/97 | H. Demroff | Incoming Inspection and test procedure for FLT Rev D TRE circuit on Sapphire carrier | √ | N/A | Approved | | √ | √ |

Detector Package Test

| Document | Revision Date | Author | Title | Written | In Database | Approval Status | Dwg Ref | Flow Ref | Verif Ref |
|----------|---------------|-----------|---|---------|-------------|-----------------|---------|----------|-----------|
| P0392 | 1/27/98 | J Goebel | Detector Package Assembly (DPA) Acceptance Test Procedure | √ | | In-Review | | | √ |
| P0358 | 1/28/98 | J. Goebel | Telescope Detector Mount Assembly Vibration testing | √ | | Draft | | | √ |

Additional Documents

| Docu ment | Date | Author | Title | Writt en | In Databas e | Approval Status | Dwg Ref | Flow Ref | Verif Ref |
|--------------------|--------------|------------|---|-------------|--------------------|--------------------|------------|-------------|--------------|
| P0057 A | 9/29/94 | J Lockhart | GP-B Magnetic Control Plan - Science Mission | √ | | Approved | √ | | |
| P0059 C | 6/19/94 | M Keiser | GP-B Contamination Control Plan (Probe B) | √ | | Approved | √ | | |
| P0080 | 9/5/97 | J Lockhart | Cryogenic Magnetic Screening Procedure | √ | | | √ | | |
| P0357 | 2/10/98 | H Demroff | Procedure for DPA Electrostatic Discharge Precaution | √ | | Approved | | √ | |
| 23200 -119 C | 12/12/9 7 | B Taller | DRAWING TREE, DETECTOR PACKAGE KIT, SM | √ | √ | Approved | | | |
| 25712 -101 | 11/26/9 7 | M Sullivan | DETECTOR PACKAGE KIT, CHANNEL A | √ | √ | Approved | | | |
| 25712 -102 | 11/26/9 7 | M Sullivan | DETECTOR PACKAGE KIT, CHANNEL B | √ | √ | Approved | | | |